

ABSTRACT

A first driver IC is mounted in the area which includes one side of the panel substrate on an electro-optical panel, and the edge portion of the film base material on which a second driver IC is mounted is bonded to the vicinity of the one side of the above-mentioned panel substrate. Also, driver-controlling electronic components which each provides control signals to the first and second driver ICs are mounted on the same surface as the second driver IC in the film base material.

